

WEDNESDAY 22 MARCH

DAY 1

THURSDAY 23 MARCH

DAY 2

Time	Room 1	Room 2	Room 3	Room 1	Room 2	Room 3	Time
08:00	Registration & refreshments			Registration & refreshments			08:00
08:15	Registration & refreshments			Registration & refreshments			08:15
08:30	Registration & refreshments			Registration & refreshments			08:30
08:45	Registration & refreshments			Registration & refreshments			08:45
09:00	OPENING of ILAS 2023			Registration & refreshments			09:00
09:15	Plenary 1 Okamoto, Yasuhiro (Okayama University, Japan)			Surface Engineering/Texturing Keynote: Girolamo Mincuzzi (Alphanov)	Sources Keynote: Eric Mottay (Amplitude)	Welding	09:15
09:30	Plenary 2 Hernandez-Gomez, Christina (STFC)			Surface Engineering/Texturing Keynote: Girolamo Mincuzzi (Alphanov)	Sources Keynote: Eric Mottay (Amplitude)	Welding	09:30
09:45	Plenary 2 Hernandez-Gomez, Christina (STFC)			Surface Engineering/Texturing Keynote: Girolamo Mincuzzi (Alphanov)	Sources Keynote: Eric Mottay (Amplitude)	Welding	09:45
10:00	Refreshment break			Refreshment break			10:00
10:15	Refreshment break			Refreshment break			10:15
10:30	Refreshment break			Refreshment break			10:30
10:45	Welding Keynote: Wojciech Suder (Cranfield U.)	Additive Manufacturing (DED) Keynote: Mario Cordero (Welding Alloys)	Beam Delivery & Shaping Keynote: Gwenn Pallier (Cailabs)	AI & Machine Learning Keynote: Ben Mills (U. Southampton)	Microfabrication Keynote: Philippe Leopold (Lumentum Technology)	Welding for e-Mobility	10:45
11:00	Welding Keynote: Wojciech Suder (Cranfield U.)	Additive Manufacturing (DED) Keynote: Mario Cordero (Welding Alloys)	Beam Delivery & Shaping Keynote: Gwenn Pallier (Cailabs)	AI & Machine Learning Keynote: Ben Mills (U. Southampton)	Microfabrication Keynote: Philippe Leopold (Lumentum Technology)	Welding for e-Mobility	11:00
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12:00	Lunch			Lunch			12:00
12:15	Lunch			Lunch			12:15
12:30	Lunch			Lunch			12:30
12:45	Lunch			Lunch			12:45
13:00	Lunch			Lunch			13:00
13:15	Lunch			Lunch			13:15
13:30	Cleaning Keynote: Jack Gabzdyl (TRUMPF Laser)	Additive Manufacturing (LPBF) Keynote: Andrew Moore (Heriot-Watt University)	Surface Engineering (LSP) Keynote: Pratik Shukla (MTC)	Cutting Keynote: Steve Kidd (PowerPhotonic)	Additive Manufacturing Keynote: Mark Keating (Flow Science)	Surface Engineering/Texturing Keynote: Raul Garcia (Microrelleus)	13:30
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14:45	Refreshment break			Refreshment break			14:45
15:00	Refreshment break			Refreshment break			15:00
15:15	Refreshment break			Refreshment break			15:15
15:30	Marking & Ablation Keynote: Sławek Bogusz (Fluence)	Systems & Automation Keynote: Roland Mayerhofer (Coherent)	Drilling Keynote: Vahid Nasrollahi (U. Birmingham)	Plenary 3 Aboulkhair, Nesma (Technology Innovation Institute, UAE)			15:30
15:45	Marking & Ablation Keynote: Sławek Bogusz (Fluence)	Systems & Automation Keynote: Roland Mayerhofer (Coherent)	Drilling Keynote: Vahid Nasrollahi (U. Birmingham)	Plenary 3 Aboulkhair, Nesma (Technology Innovation Institute, UAE)			15:45
16:00	Marking & Ablation Keynote: Sławek Bogusz (Fluence)	Systems & Automation Keynote: Roland Mayerhofer (Coherent)	Drilling Keynote: Vahid Nasrollahi (U. Birmingham)	Plenary 4 Lasagni, Andres (Technical University of Dresden, Germany)			16:00
16:15	Marking & Ablation Keynote: Sławek Bogusz (Fluence)	Systems & Automation Keynote: Roland Mayerhofer (Coherent)	Drilling Keynote: Vahid Nasrollahi (U. Birmingham)	Plenary 4 Lasagni, Andres (Technical University of Dresden, Germany)			16:15
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18:30-19:15	Networking Drinks Reception
19:15	Symposium Dinner